



PFM Asynchronous Step-up DC to DC Converter (100mA)

Features

• Low start-up voltage: 0.7V (Typ.), 0.9V (Max.)

• High efficiency: 85% (Typ.), V_{OUT}≥2.7V

• High output voltage accuracy: ±2.5%

Output voltage: 1.8V, 2.2V, 2.7V, 3.0V, 3.3V, 3.7V, 5.0V

· Output current up to 100mA

- Ultra low supply current I_{DD2}: 4μA (Typ.)
- · Low ripple and low noise
- Low shutdown current: 0.5μA (Typ.)
- 3-pin TO92, 3-pin SOT89, 3-pin SOT23 and 5-pin SOT23 package

Applications

- Palmtops/PDAs
- Portable communicators/Smartphones
- Cameras/Camcorders
- · Battery-powered equipment

General Description

The HT77xx series is a set of PFM step-up DC/DC converter with high efficiency and low ripple. The series features extremely low start-up voltage and high output voltage accuracy. They require only three external components to provide a fixed output voltage of 1.8V, 2.2V, 2.7V, 3.0V, 3.3V, 3.7V or 5.0V. CMOS technology ensures ultra low supply current and makes them ideal for battery-operated applications powered from one or more cells.

The HT77xx consists of an oscillator, a PFM control circuit, a driver transistor, a reference voltage unit, and a high speed comparator. They employ pulse frequency modulation (PFM) for minimum supply current and ripple at light output loading. These devices are available in space saving 3-pin TO92, 3-pin SOT89, 3-pin SOT23 and 5-pin SOT23 packages. For 5-pin SOT23 package, it also build-in a chip enable function to reduce power consumption during shutdown mode.

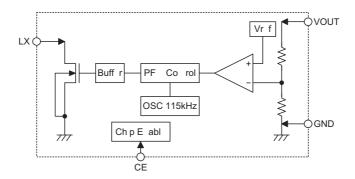
Selection Table

Part No.	Output Voltage	Package	Marking	
HT7718	1.8V			
HT7722	2.2V			
HT7727	2.7V	TO92	HT77xx (for TO92)	
HT7730	3.0V	SOT89 SOT23	HT77xx (for SOT89) 77xx (for SOT23)	
HT7733	3.3V	SOT23-5	77xx (for SOT23-5)	
HT7737	3.7V			
HT7750	5.0V			

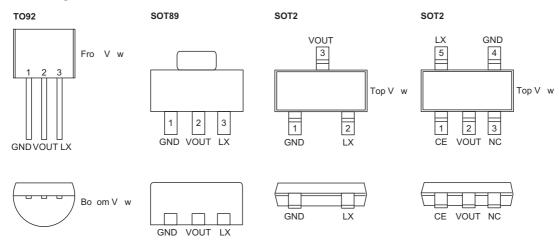
Note: "XX" stands for output voltages.



Block Diagram



Pin Assignment



Pin Description

	Pin	No.		Pin Name	Description
TO92	SOT89	SOT23	SOT23-5	Pin Name	Description
_	_		1	CE	Chip enable pin, high active
2	2	3	2	VOUT	DC/DC converter output monitoring pin
_	_	_	3	NC	No connection
1	1	1	4	GND	Ground pin
3	3	2	5	LX	Switching pin

Absolute Maximum Ratings

Supply VoltageV _{SS} -0.3V to V _{SS} +7V	Storage Temperature50°C to 125°C
Operating Temperature40°C to 85°C	

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

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Thermal Information

Symbol	Parameter	Package	Max.	Unit
		SOT89	300	°C/W
	Thermal Resistance (Junction to Ambient)	TO92	300	°C/W
θJA	θ _{JA} (Assume no ambient airflow, no heat sink)	SOT23	330	°C/W
		SOT23-5	320	°C/W
	P _D Power Dissipation	SOT89	0.33	W
D ₋		TO92	0.33	W
P _D		SOT23	0.3	W
		SOT23-5	0.31	W

Note: P_D is measured at Ta= 25°C

Electrical Characteristics

 $V_{IN} \!\!=\!\! V_{OUT} \!\!\times\!\! 0.6; \, I_{OUT} \!\!=\!\! 10 mA; \, Ta \!\!=\!\! 25^{\circ} C \, \, (Unless \, otherwise \, specified)$

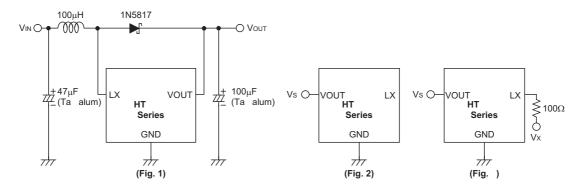
Symbol	Parameter	Test Condition	ons	Min.	Тур.	Max.	Unit
V _{IN}	Input Voltage	_		_	_	6	V
ΔV_{OUT}	Output Voltage Tolerance	_		-2.5	_	2.5	%
V _{START}	Start-up Voltage (Fig. 1)	V _{IN} : 0→2V; I _{OUT} =1mA		_	0.7	0.9	V
V _{HOLD}	Minimum Hold-on Voltage (Fig. 1)	V _{IN} : 2→0V; I _{OUT} =1mA		_	_	0.7	V
I _{IN}	No-load Input Current (Fig. 1)	I _{OUT} =0mA		_	10	20	μА
			V _{OUT} =1.8V	_	35	50	
			V _{OUT} =2.2V	_	37	55	
			V _{OUT} =2.7V	_	40	60	
I _{DD1}	Supply Current 1 (Fig. 2)	V _S =V _{OUT} ×0.95 Measured at V _{OUT} pin	V _{OUT} =3.0V	_	45	68	μΑ
		Wedsured at VOUT pill	V _{OUT} =3.3V	_	55	81	
	V _{OUT} =3.7V	V _{OUT} =3.7V	_	64	85		
			V _{OUT} =5.0V	_	85	134	134
I _{DD2}	Supply Current 2 (Fig. 2)	V _S =V _{OUT} +0.5V Measured at V _{OUT} pin		_	4	7	μА
I _{SHDN}	Shutdown Current	CE=GND		_	0.5	1	μА
V _{IH}	CE High Threshold	_		2	_	_	V
V _{IL}	CE Low Threshold	_		_	_	0.4	V
I _{LEAK}	LX Leakage Current (Fig. 3)	V_S = V_{OUT} +0.5 V , V_X =6 V Measured at the LX pin		_	_	0.9	μА
f _{OSC}	Maximum Oscillator Frequency (Fig. 3)	V _S =V _{OUT} ×0.95 Measured at LX pin		_	115	_	kHz
D _{OSC}	Oscillator Duty Cycle (Fig. 3)	V _S =V _{OUT} ×0.95 Measured at LX pin		65	75	85	%
	F.C. :	V _{OUT} ≤2.2V		_	80	_	0/
η Efficiency		V _{OUT} ≥2.7V		_	85	_	%

Note: Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. The guaranteed specifications apply only for the test conditions listed.

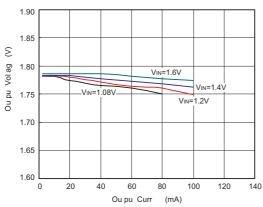
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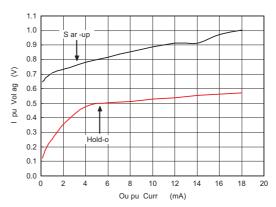


Test Circuit



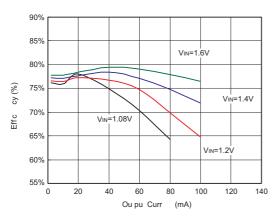
Typical Performance Characteristics

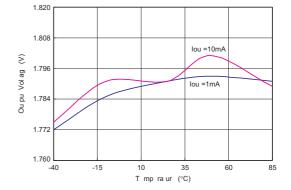




HT7718 Output Voltage v.s Output Current

HT7718 Start-Up& Hold-On Voltage

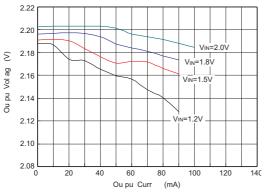




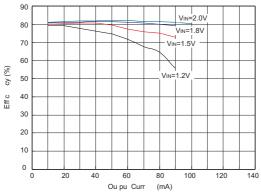
HT7718 Efficiency v.s Output Current

HT7718 Temperature v.s Output Voltage

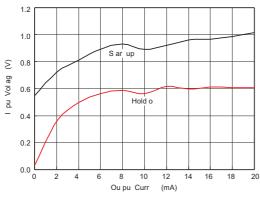




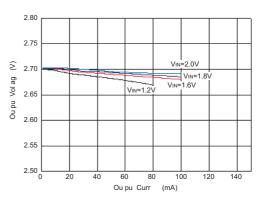
HT7722 Output Voltage v.s Output Current



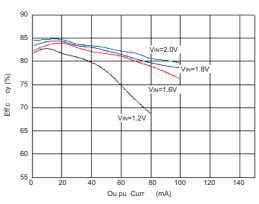
HT7722 Efficiency v.s Output Current



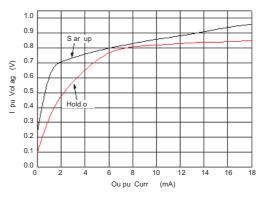
HT7722 Start-Up& Hold-On Voltage



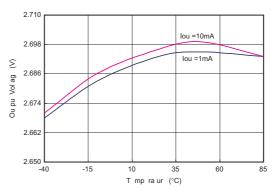
HT7727 Output Voltage v.s Output Current



HT7727 Efficiency v.s Output Current

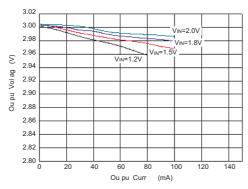


HT7727 Start-Up& Hold-On Voltage

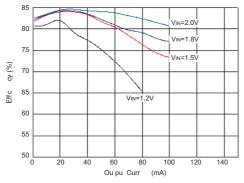


HT7727 Temperature v.s Output Voltage

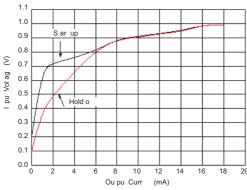




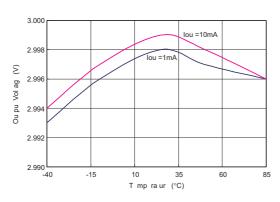




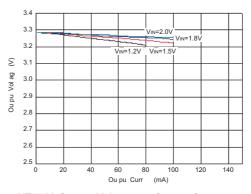
HT7730 Efficiency v.s Output Current



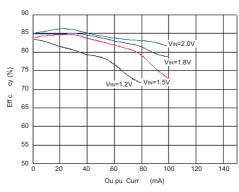
HT7730 Start-Up& Hold-On Voltage



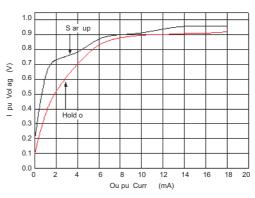
HT7730 Temperature v.s Output Voltage



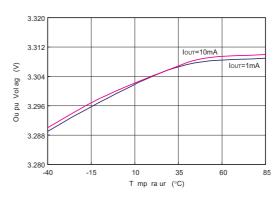
HT7733 Output Voltage v.s Output Current



HT7733 Efficiency v.s Output Current

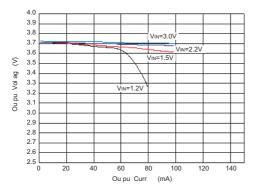


HT7733 Start-Up& Hold-On Voltage

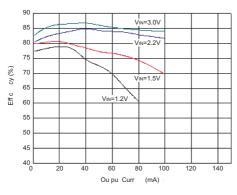


HT7733 Temperature v.s Output Voltage

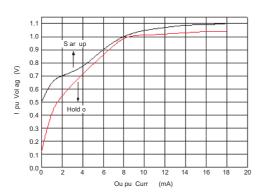




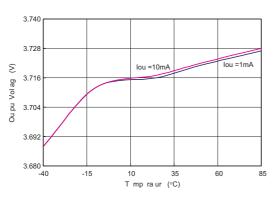
HT7737 Output Voltage v.s Output Current



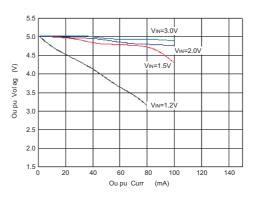
HT7737 Efficiency v.s Output Current



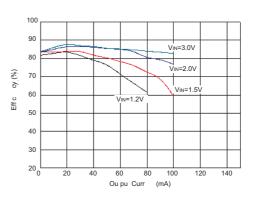
HT7737 Start-Up& Hold-On Voltage



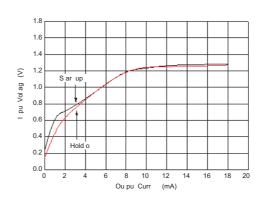
HT7737 Temperature v.s Output Voltage



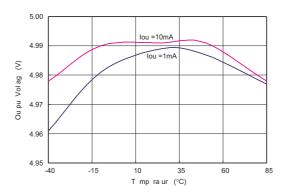
HT7750 Output Voltage v.s Output Current



HT7750 Efficiency v.s Output Current

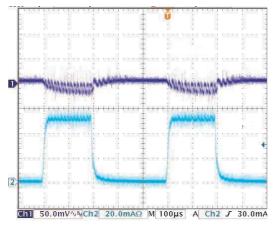


HT7750 Start-Up& Hold-On Voltage

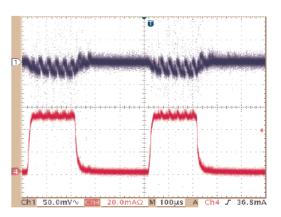


HT7750 Temperature v.s Output Voltage

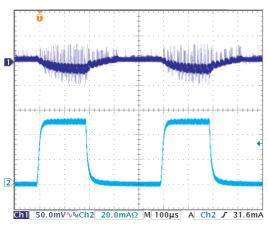




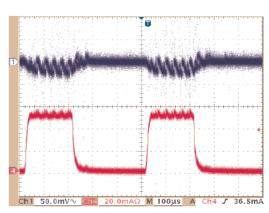
HT7718 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=1.08V)



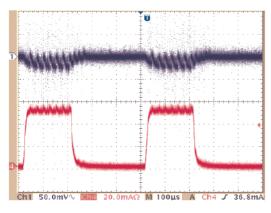
HT7730 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=1.8V)



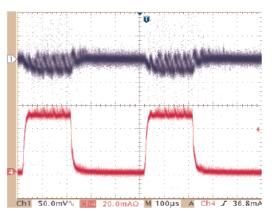
HT7722 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=1.08V)



HT7733 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=1.98V)

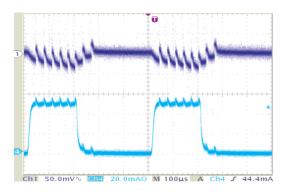


HT7727 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=1.62V)

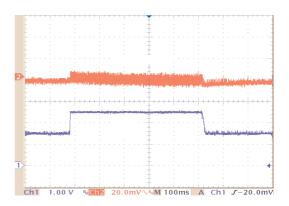


HT7737 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=2.22V)

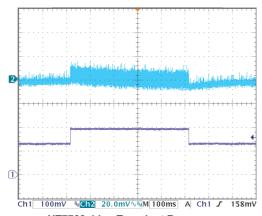




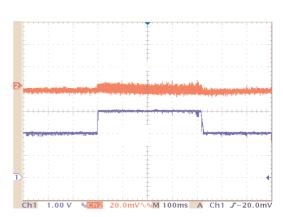
HT7750 Load Transient Response (L=100 μ H, C_{OUT}=100 μ F, V_{IN}=3V)



HT7733 Line Transient Response (L=100 μ H, C_{OUT}=100 μ F)



HT7722 Line Transient Response (L=100 μ H, C_{OUT}=100 μ F)

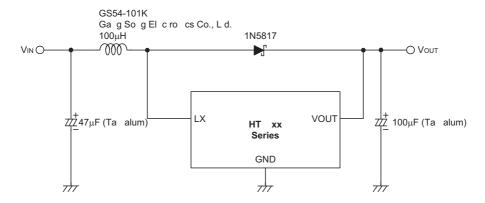


HT7750 Line Transient Response (L=100 μ H, C_{OUT}=100 μ F)

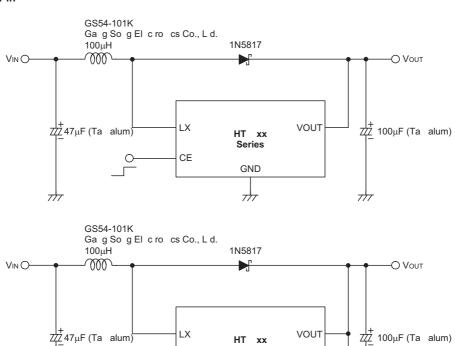


Application Circuits

Without CE Pin



With CE Pin



Note: For the 5-pin SOT23 package, when CE is pulled low, the internal blocks of the device, such as the reference band gap, gain block, and all feedback and control circuitry will be switched off. The boost converter's output, V_{OUT}, will be at a value one Schottky diode voltage drop below the input voltage and the LX pin remains in a high impedance condition. The output capacitor and load at V_{OUT} determine the rate at which V_{OUT} decays.

CE

7

Series

GND

//

1



Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the <u>Holtek website</u> for the latest version of the <u>package information</u>.

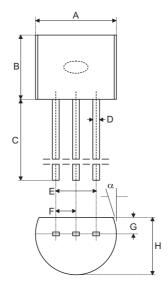
Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Further Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- Packing Meterials Information
- Carton Information

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3-pin TO92 Outline Dimensions

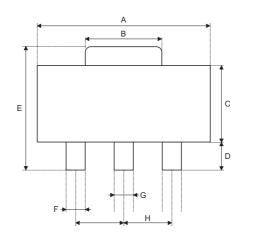


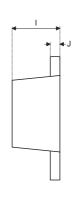
Symbol	Dimensions in inch				
	Min.	Nom.	Max.		
A	0.173	0.180	0.205		
В	0.170	_	0.210		
С	0.500	0.580			
D	_	0.015 Typ	_		
Е	_	0.010 Typ			
F	_	0.050 Typ	_		
G	_	0.035 Typ	_		
Н	0.125	0.142	0.165		

Symbol	Dimensions in mm				
Symbol	Min.	Nom.	Max.		
A	4.39	4.57	5.21		
В	4.32	_	5.33		
С	12.70	14.73	_		
D	_	0.38 Typ	_		
E	_	2.54 Typ	_		
F	_	1.27 Typ	_		
G	_	0.89 Тур	_		
Н	3.18	3.61	4.19		



3-pin SOT89 Outline Dimensions



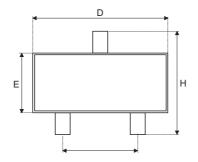


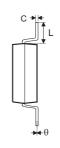
Cumhal	Dimensions in inch				
Symbol	Min.	Nom.	Max.		
Α	0.173	_	0.181		
В	0.053	_	0.072		
С	0.090	_	0.102		
D	0.035	_	0.047		
E	0.155	_	0.167		
F	0.014	_	0.019		
G	0.017	_	0.022		
Н	_	0.059 BSC	_		
I	0.055	_	0.063		
J	0.014	_	0.017		

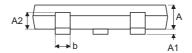
Cumbal	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
A	4.40	_	4.60	
В	1.35	_	1.83	
С	2.29	_	2.60	
D	0.89	_	1.20	
Е	3.94	_	4.25	
F	0.36	_	0.48	
G	0.44	_	0.56	
Н	_	1.50 BSC	_	
I	1.40	_	1.60	
J	0.35	_	0.44	



3-pin SOT23 Outline Dimensions





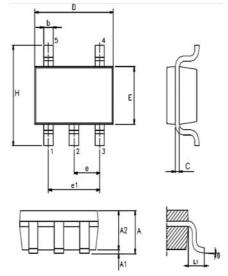


Cumhal	Dimensions in inch				
Symbol	Min.	Nom.	Max.		
Α	_	_	0.057		
A1	_	_	0.006		
A2	0.035	0.045	0.051		
b	0.012	_	0.020		
С	0.003	_	0.009		
D	_	0.114 BSC	_		
E	_	0.063 BSC	_		
е	_	0.037 BSC	_		
Н	_	0.075 BSC	_		
L	_	0.110 BSC	_		
L1	_	0.024 BSC	_		
θ	0°	_	8°		

Cymphal	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
Α	_	_	1.45	
A1	_	_	0.15	
A2	0.90	1.15	1.30	
b	0.30	_	0.50	
С	0.08	_	0.22	
D	_	2.90 BSC	_	
E	_	1.60 BSC	_	
е	_	0.95 BSC	_	
Н	_	1.90 BSC	_	
L	_	2.80 BSC	_	
L1	_	0.60 BSC	_	
θ	0°	_	8°	



5-pin SOT23 Outline Dimensions



Complete	Dimensions in inch				
Symbol	Min.	Nom.	Max.		
Α	_	_	0.057		
A1	_	_	0.006		
A2	0.035	0.045	0.051		
b	0.012	_	0.020		
С	0.003	_	0.009		
D	_	0.114 BSC	_		
E	_	0.063 BSC	_		
е	_	0.037 BSC	_		
Н	_	0.075 BSC	_		
L	_	0.110 BSC	_		
L1	_	0.024 BSC	_		
θ	0°	_	8°		

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
Α	_	_	1.45
A1	_	_	0.15
A2	0.90	1.15	1.30
b	0.30	_	0.50
С	0.08	_	0.22
D	_	2.90 BSC	_
E	_	1.60 BSC	_
е	_	0.95 BSC	_
Н	_	1.90 BSC	_
L	_	2.80 BSC	_
L1	_	0.60 BSC	_
θ	0°	_	8°



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